

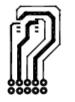
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-80			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-61		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -64 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics			- <u>1</u>		•
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{II}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		5		mV/°C
J	Static Drain to Source On Resistance	V _{GS} = -10 V, I _D = -2.1 A		148	183	mΩ
r _{DS(on)}		$V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$		176	247	
20(01)		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.1 \text{ A}, \text{T}_{J} = 125 \text{ °C}$		249	308	
9 _{FS}	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.1 \text{ A}$		6.4		S
2 _{oss}		V _{DS} = -40 V, V _{GS} = 0 V,		47	63	pF
C _{rss}	Output Capacitance Reverse Transfer Capacitance Gate Resistance	f = 1MHz		24 6	36	, pF
C _{rss} R _g	Reverse Transfer Capacitance Gate Resistance	f = 1MHz		24		· ·
C _{rss} R _g Switching	Reverse Transfer Capacitance Gate Resistance g Characteristics	f = 1MHz		24 6		pF
C _{rss} R _g Switchinę	Reverse Transfer Capacitance Gate Resistance			24	36	pF Ω
C _{rss} R _g Switching t _{d(on)} t _r	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	f = 1MHz V _{DD} = -40 V, I _D = -2.1 A, V _{GS} = -10 V, R _{GEN} = 6 Ω		24 6 5	36 10	pF Ω ns
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	V _{DD} = -40 V, I _D = -2.1 A,		24 6 5 3	36 10 10	pF Ω ns ns
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V_{DD} = -40 V, I _D = -2.1 A, V _{GS} = -10 V, R _{GEN} = 6 Ω		24 6 5 3 22	36 10 10 36	pF Ω ns ns ns
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V _{DD} = -40 V, I _D = -2.1 A,		24 6 5 3 22 3	36 10 10 36 10	pF Ω ns ns ns ns
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{g(TOT)}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$		24 6 5 3 22 3 13	36 10 10 36 10 19	pF Ω ns ns ns ns nC
C _{rss} R _g Switchinų t _d (on) t _r Q _{g(TOT)} Q _{g(TOT)} Q _{gs}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -5 \text{ V}$ $V_{DD} = -40 \text{ V},$		24 6 5 3 22 3 13 7	36 10 10 36 10 19	pF Ω ns ns ns nc nC
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{g(TOT)} Q _{gs} Q _{gd}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate Charge Gate to Source Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -5 \text{ V}$ $V_{DD} = -40 \text{ V},$		24 6 5 3 22 3 13 7 1.6	36 10 10 36 10 19	pF Ω ns ns ns nC nC
$\begin{array}{c} C_{rss} \\ R_{g} \\ \hline \\ $	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{GS} = 0 \text{ V to } -5 \text{ V}$ $V_{DD} = -40 \text{ V},$ $I_{D} = -2.1 \text{ A}$		24 6 5 3 22 3 13 7 1.6	36 10 10 36 10 19 10	pF Ω ns ns ns nc nC nC nC
C _{rss} R _g Switching t _{d(on)} t _r Q _{g(TOT)} Q _{g(TOT)} Q _{gg} Q _{gd} Drain-So	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{DD} = -40 \text{ V},$ $I_{D} = -2.1 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -2.1 \text{ A}$ (Note 2)		24 6 5 3 22 3 13 7 1.6 2.6	36 10 10 36 10 19	pF Ω ns ns ns nC nC
C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{g(TOT)} Q _{gs} Q _{gd}	Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -40 \text{ V}, \text{ I}_{D} = -2.1 \text{ A},$ $V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } -10 \text{ V}$ $V_{DD} = -40 \text{ V},$ $I_{D} = -2.1 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = -2.1 \text{ A}$ (Note 2)		24 6 5 3 22 3 13 7 1.6 2.6 -1.8	36 10 10 36 10 19 10 -1.3	pF Ω ns ns ns nc nC nC nC

R_{θJA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.



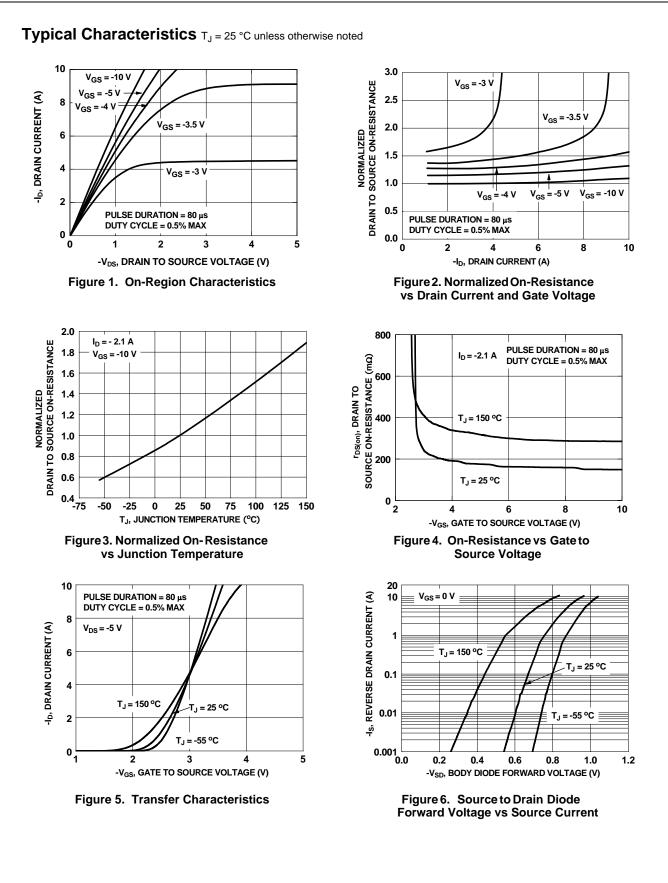
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. Starting T_J = 25 °C, L = 3.0 mH, I_{AS} = -5.0 A, V_DD = -80V, V_GS = -10V.



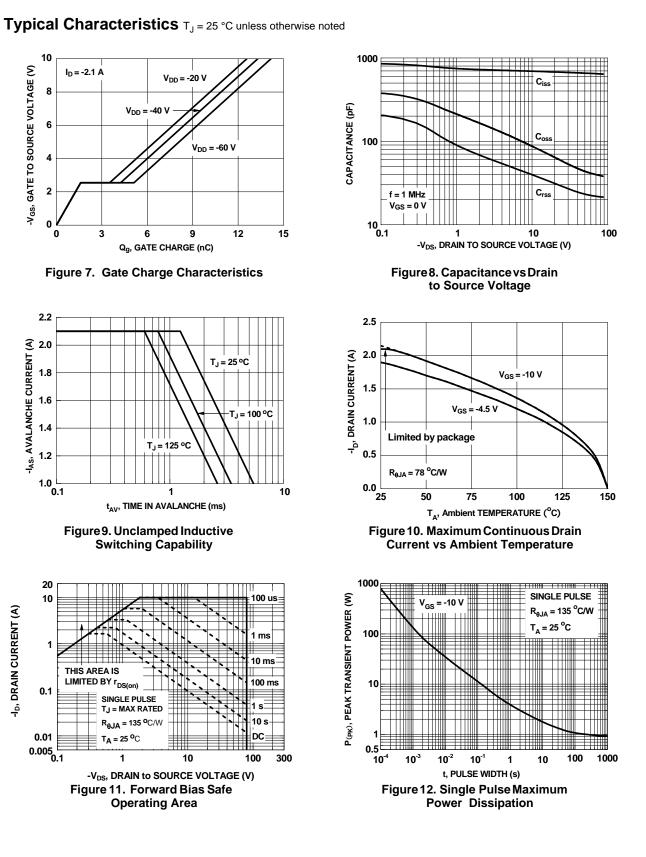


b)135 °C/W when mounted on a minimun pad

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10

8

6

4

2

0

2.2

-l_{AS}, AVALANCHE CURRENT (A) 7.1 9.1 8.1 (A) 7.1 9.1 10.1 (A)

1.0 0.1

20

10

1

0.1

0.01

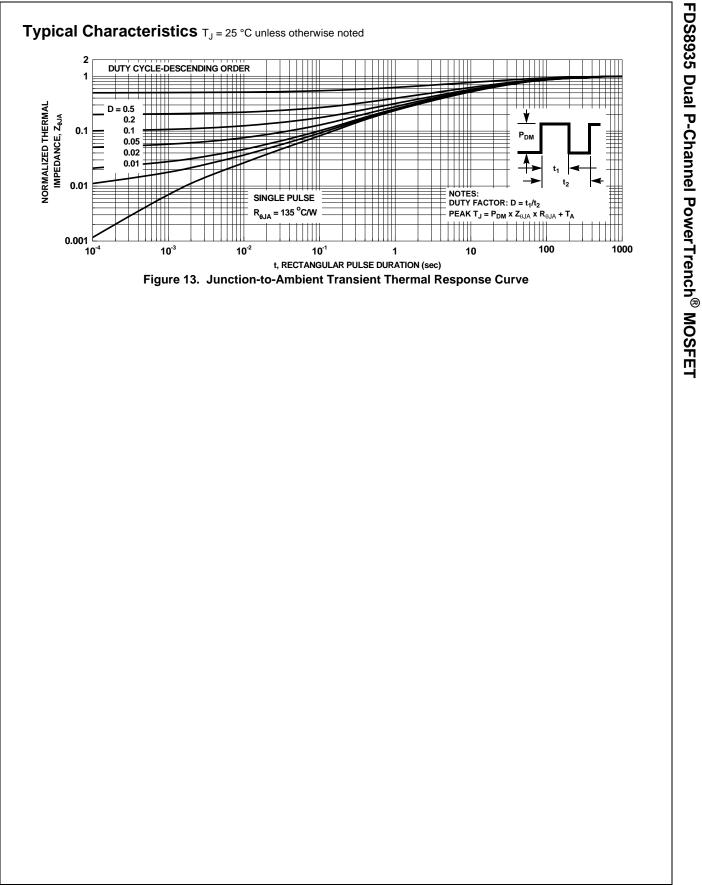
0.005 [⊟] 0.1

H_D, DRAIN CURRENT (A)

0

-V_{GS}, GATE TO SOURCE VOLTAGE (V)

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